



IEEE

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A photograph of industrial machinery, likely a large motor or generator, with a complex arrangement of metal parts, including a large circular component with a grid of holes and various pipes and bolts. The lighting is dramatic, with strong highlights and deep shadows.

**IEEE Student Conference on Research and
Development (SCOREd) 2017**
13-14 December | Putrajaya, Malaysia

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Message From the Editor



Dear readers,

I would like to present to you the third edition of the 2017 IEEE Malaysia Section Newsletter. This issue mainly covers activities that have been conducted by Section, Chapters, Affinity Groups and Student Branches between month of July to September, 2017.

In this issue we have received 15 articles from technical chapters and affinity group. This equivalent to approximately 50% of submission out of all the technical chapters and affinity groups that available under the Malaysia Section. This issue also seen of zero submission from student branches which leads to our wonder why. The declining numbers of submission may be either due to less activities are conducted within this period or there are activities running but the report is not yet available to be submitted. For either case, we are hoping that it will be recovered in the next issue.

Finally, thank you to all the submitters for this issue. To the rest, Happy Reading!!!

Rosmiwati Mohd Mokhtar, Editor – IEEE Malaysia Section Newsletter